



SSC8640GS1

N and P-Channel Enhancement Mode Power MOSFET

➤ Features

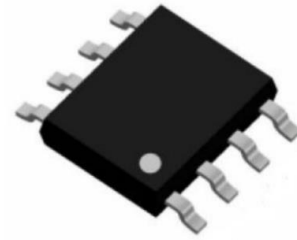
N-Channel

V _{DS}	V _{GS}	R _{DS(ON)} Typ.	I _D
40V	±20V	15mΩ@10V	8A
		20mΩ@4V5	

P-Channel

V _{DS}	V _{GS}	R _{DS(ON)} Typ.	I _D
-40V	±20V	26mΩ@-10V	-7A
		34mΩ@-4V5	

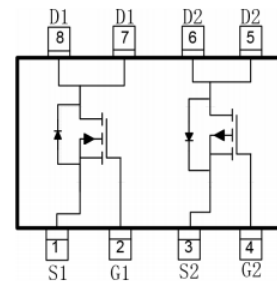
➤ Pin configuration



SOP-8

➤ Description

The SSC8640GS1 uses advanced trench technology to provide excellent RDS(ON) and low gate charge. The complementary MOSFETs may be used to form a level shifted high side switch, and for a host of other applications.



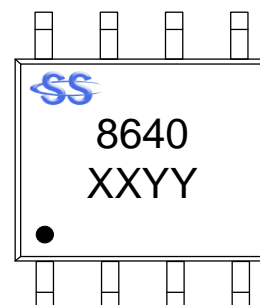
Pin Configuration (Top View)

➤ Applications

- PWM Applications
- Load Switch
- DC-DC Converters
- Wireless Chargers

➤ Ordering Information

Device	Package	Shipping
SSC8640GS1	SOP-8	2500/Reel



Marking (Top View)



➤ **Absolute Maximum Ratings ($T_A=25^{\circ}\text{C}$ unless otherwise noted)**

Parameter	Symbol	N-Channel	P-Channel	Unit
Drain-to-Source Voltage	V_{DSS}	40	-40	V
Gate-to-Source Voltage	V_{GSS}	± 20	± 20	V
Continuous Drain Current ^c	I_D	8	-7	A
Pulsed Drain Current ^b	I_{DM}	40	-30	A
Power Dissipation ^c	P_D	2	2	W
Operation junction temperature	T_J	-55 to 150	-55 to 150	$^{\circ}\text{C}$
Storage temperature range	T_{STG}	-55 to 150	-55 to 150	$^{\circ}\text{C}$

➤ **Thermal Resistance Ratings ($T_A=25^{\circ}\text{C}$ unless otherwise noted)**

Symbol	Parameter	Channel	Ratings	Unit
$R_{\theta JA}$	Junction-to-Ambient Thermal Resistance ^a	N-Channel	63	$^{\circ}\text{C}/\text{W}$
$R_{\theta JA}$	Junction-to-Ambient Thermal Resistance ^a	P-Channel	63	

Note:

- The value of $R_{\theta JA}$ is measured with the device mounted on 1 in² FR-4 board with 2oz.copper, in a still air environment with $T_A=25^{\circ}\text{C}$. The value in any given application depends on the user's specific board design. The current rating is based on the $t \leq 10\text{s}$ thermal resistance rating.
- Repetitive rating, pulse width limited by junction temperature.
- The power dissipation P_D is based on $T_{J(MAX)}=150^{\circ}\text{C}$, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.



➤ **N-Channel Electrical Characteristics (T_A=25°C unless otherwise noted)**

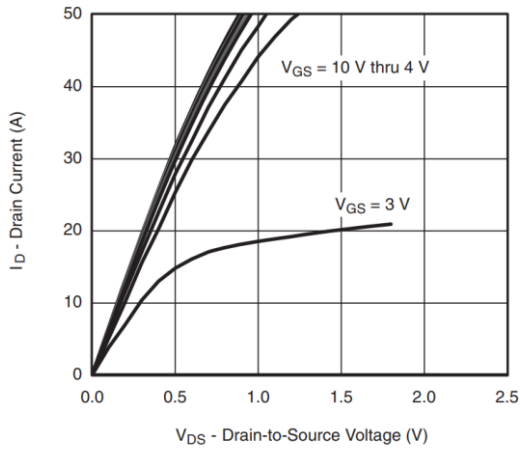
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	40			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250uA	1	1.5	2	V
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} = 10V, I _D = 8A		15	21	mΩ
		V _{GS} = 4.5V, I _D = 4A		20	29	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 40V, V _{GS} = 0V			-1	μA
Gate-Source Leak Current	I _{GSS}	V _{GS} = ±20V, V _{DS} = 0V			±100	nA
Transconductance	G _{FS}	V _{DS} = 5V, I _D = 8A		35		s
Forward Voltage	V _{SD}	V _{GS} = 0V, I _S = 8A		0.8	1.2	V
Input Capacitance	C _{ISS}	V _{DS} = 20V, V _{GS} = 0V, f = 1MHz		920		pF
Output Capacitance	C _{OSS}			96		
Reverse Transfer Capacitance	C _{RSS}			94		
Total Gate Charge	Q _G	V _{GS} = 10V, V _{DS} = 20V, I _D = 8A		29		nC
Gate to Source Charge	Q _{GS}			4		
Gate to Drain Charge	Q _{GD}			6		
Turn-on Delay Time	T _{D(ON)}	V _{GS} = 10V, V _{DS} = 20V, R _L = 2.5Ω, R _{GEN} = 3Ω,		5.3		ns
Rise Time	T _r			13		
Turn-off Delay Time	T _{D(OFF)}			22		
Fall Time	T _f			11		

➤ **P-Channel Electrical Characteristics (T_A=25°C unless otherwise noted)**

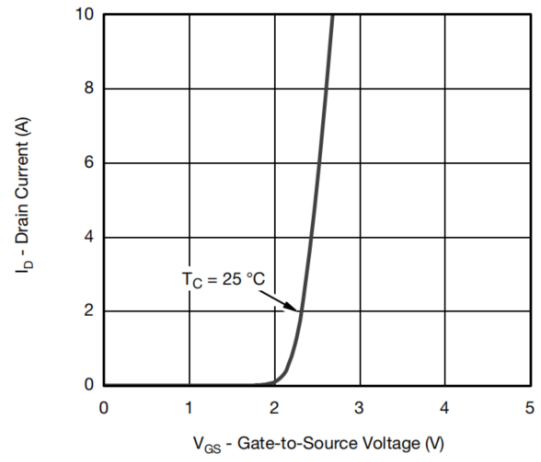
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = -250μA	-40			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = -250uA	-1	-1.5	-2	V
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} = -10V, I _D = -7A		26	45	mΩ
		V _{GS} = -4.5V, I _D = -4A		34	55	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -40V, V _{GS} = 0V			-1	μA
Gate-Source Leak Current	I _{GSS}	V _{GS} = ±20V, V _{DS} = 0V			±100	nA
Transconductance	G _{FS}	V _{DS} = -5V, I _D = -7A		20		s
Forward Voltage	V _{SD}	V _{GS} = 0V, I _S = -7A			-1.2	V
Input Capacitance	C _{ISS}	V _{DS} = -20V, V _{GS} = 0V, f = 1MHz		1120		pF
Output Capacitance	C _{OSS}			120		
Reverse Transfer Capacitance	C _{RSS}			108		
Total Gate Charge	Q _G	V _{GS} = -20V, V _{DS} = -10V, I _D = -7A		22		nC
Gate to Source Charge	Q _{GS}			2.2		
Gate to Drain Charge	Q _{GD}			5		
Turn-on Delay Time	T _{D(ON)}	V _{GS} = -10V, V _{DS} = -20V, R _L = 2.9Ω, R _G = 6Ω,		7.5		ns
Rise Time	T _r			5.4		
Turn-off Delay Time	T _{D(OFF)}			19		
Fall Time	T _f			7.2		



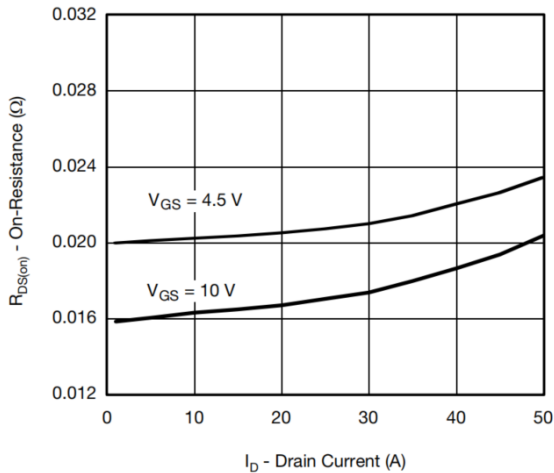
➤ N-Channel Typical Performance Characteristics ($T_A=25^\circ\text{C}$ unless otherwise noted)



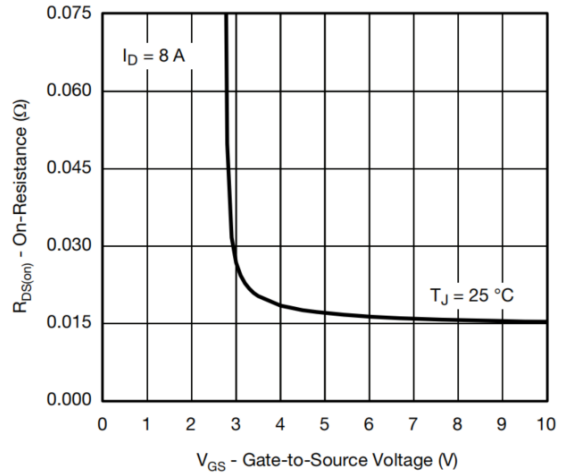
Output Characteristics



Transfer Characteristics

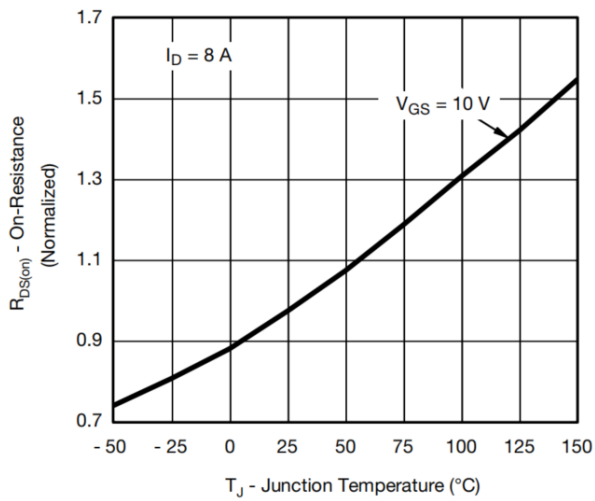


On-Resistance vs. Drain Current

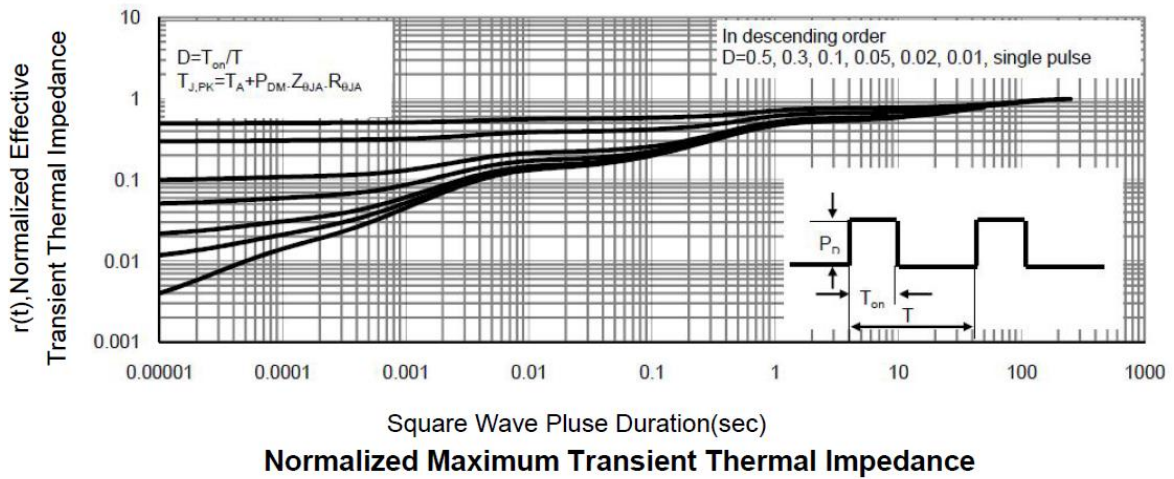


On-Resistance vs. Gate-to-Source Voltage

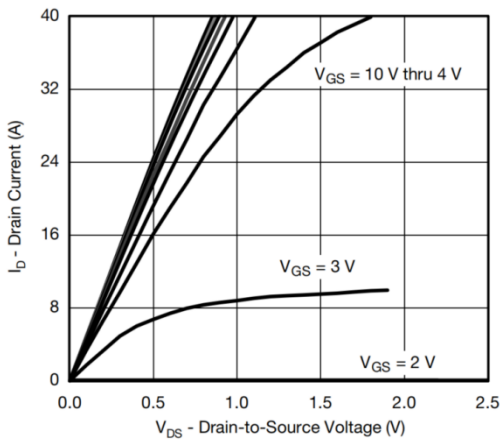
Capacitance



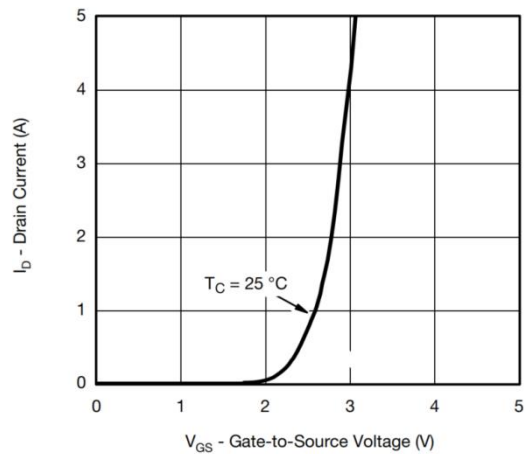
On-Resistance vs. Junction Temperature



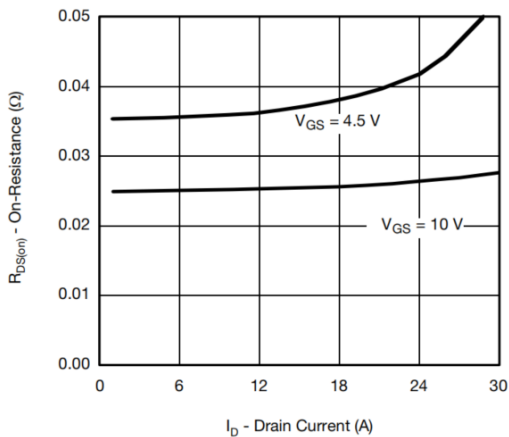
➤ **P-Channel Typical Performance Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise noted)**



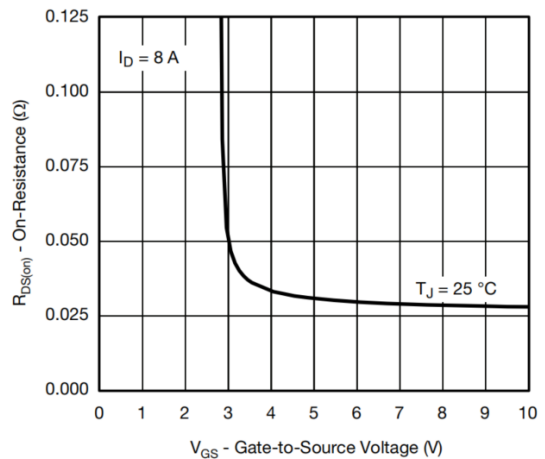
Output Characteristics



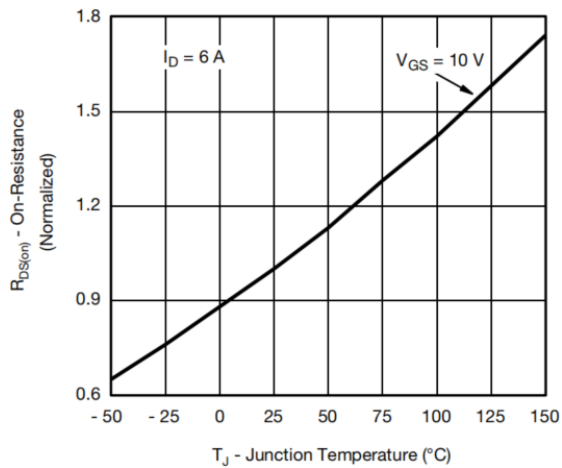
Transfer Characteristics



On-Resistance vs. Drain Current



On-Resistance vs. Gate-to-Source Voltage



On-Resistance vs. Junction Temperature

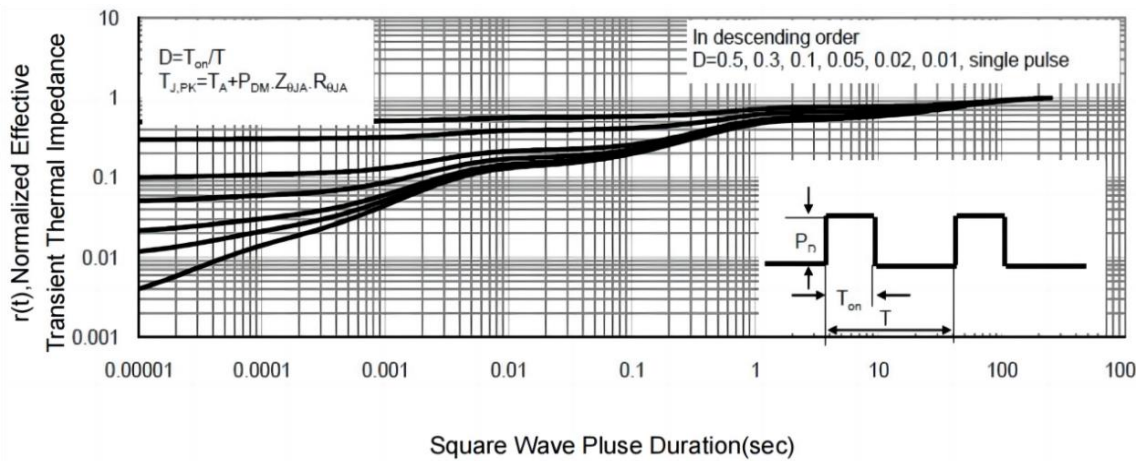
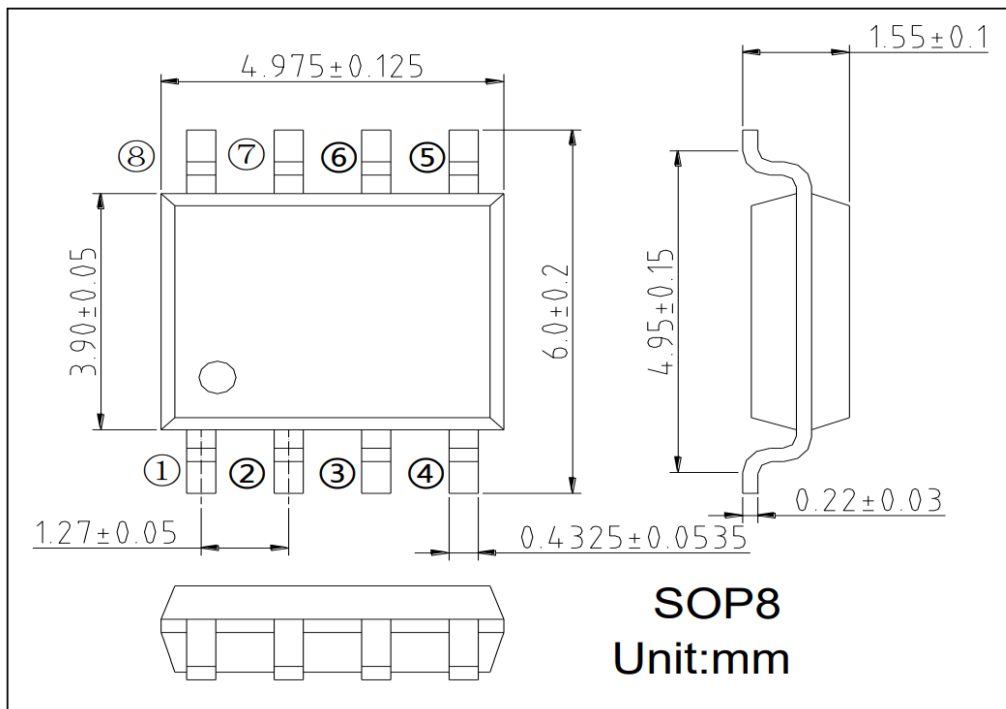


Figure 11 Normalized Maximum Transient Thermal Impedance

➤ Package Information



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